PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Ichiro HAZEMYAMA et al.

Appl. No.: 10/700,438

Filed: November 4, 2003 : Examiner: EDMONDSON, Lynne R.

Art Unit: 1725

Atty Docket: KIM-01802

For: TRANSFER APPARATUS FOR

ARRAYING SMALL

CONDUCTIVE BUMPS ON SUBSTRATE AND/OR CHIP

TERMINAL DISCLAIMER

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Petitioners NEC Corporation and Japan E.M. Co., Ltd, owners of 100% of the above-referenced application by virtue of an Assignment from the inventors recorded at reel 012741, frame 0661, hereby disclaim, except as provided below, the terminal part of any patent granted on the above-captioned application, which would extend beyond the expiration date of any patent issuing from U.S. Patent Application No. 10/105,580, filed on March 25, 2002, (hereinafter, "the Other Patent"). Petitioners hereby agree that any patent so granted on the present above-captioned application shall be enforceable only for and during such period that it and the Other Patent are commonly owned. This agreement runs with any patent granted on the above-captioned application and is binding upon the grantee, its successors, or assigns.

Petitioners do not disclaim any terminal part of any patent granted on the above-captioned application prior to the expiration date of the full statutory term of the Other Patent in the event that the Other Patent expires for failure to pay a maintenance fee, is held unenforceable, is found invalid, is statutorily disclaimed in whole or terminally disclaimed under 37 CFR 1.321(a), has all claims cancelled by a reexamination certificate, or is otherwise terminated prior to the expiration of its statutory term, except for the separation of legal title stated above.

09/02/2004 TBESHAH1 00000004 10700438

02 FC:1614

110.00 OP

Date: August 31, 2004

Patent Group Choate, Hall & Stewart Exchange Place 53 State Street Boston, MA 02109 Donald W. Muirhead Registration No. 33,978

3740671_1.DOC